

Single N-channel MOSFET with schottky diode

ELM14700AA-N

General description

ELM14700AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge.

Features

- $V_{ds}=30V$
 - $I_d=6.9A$ ($V_{gs}=10V$)
 - $R_{ds(on)} < 28m\Omega$ ($V_{gs}=10V$)
 - $R_{ds(on)} < 42m\Omega$ ($V_{gs}=4.5V$)
- Schottky diode
- $V_{ds(V)}=30V$
 - $I_f=4A$
 - $V_f < 0.5V@3A$

Maximum absolute ratings

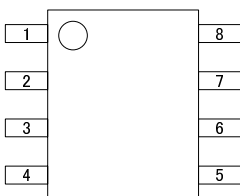
| Parameter | Symbol | MOSFET | Schottky | Unit | Note |
|----------------------------------------|------------------|------------|------------|------------|------|
| Drain-source voltage | V_{ds} | 30 | | V | |
| Gate-source voltage | V_{gs} | ± 20 | | V | |
| Continuous drain current | I_d | 6.9 | | A | 1 |
| | | | | | |
| | $T_a=70^\circ C$ | 5.8 | | | |
| Pulsed drain current | I_{dm} | 30 | | A | 2 |
| Schottky reverse voltage | V_{ka} | | 30 | V | |
| Continuous forward current | I_f | | 4.0 | A | 1 |
| | | | | | |
| | $T_a=70^\circ C$ | | 2.6 | | |
| Pulsed forward current | I_{fm} | | 40 | A | 2 |
| Power dissipation | P_d | 2.00 | 2.00 | W | |
| | | | | | |
| | $T_a=70^\circ C$ | 1.28 | 1.28 | | |
| Junction and storage temperature range | T_j, T_{stg} | -55 to 150 | -55 to 150 | $^\circ C$ | |

Thermal characteristics

| Parameter (MOSFET) | Symbol | Typ. | Max. | Unit | Note |
|-----------------------------|----------------|--------------|------|--------------|------|
| Maximum junction-to-ambient | $R\theta_{ja}$ | 48.0 | 62.5 | $^\circ C/W$ | 1 |
| Maximum junction-to-ambient | | Steady-state | 74.0 | 110.0 | |
| Maximum junction-to-lead | $R\theta_{jl}$ | 35.0 | 40.0 | $^\circ C/W$ | 3 |
| Parameter (Schottky) | Symbol | Typ. | Max. | Unit | Note |
| Maximum junction-to-ambient | $R\theta_{ja}$ | 44.0 | 62.5 | $^\circ C/W$ | 1 |
| Maximum junction-to-ambient | | Steady-state | 73.0 | 110.0 | |
| Maximum junction-to-lead | $R\theta_{jl}$ | 31.0 | 40.0 | $^\circ C/W$ | 3 |

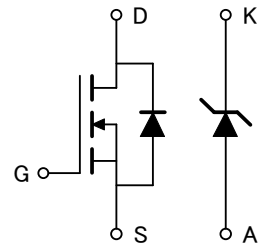
Pin configuration

SOP-8 (TOP VIEW)



| Pin No. | Pin name |
|---------|----------|
| 1 | ANODE |
| 2 | ANODE |
| 3 | SOURCE |
| 4 | GATE |
| 5 | DRAIN |
| 6 | DRAIN |
| 7 | CATHODE |
| 8 | CATHODE |

Circuit



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Electrical characteristics

T_a=25°C

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|------------------------------------|---------------------|-----------------------------------------------------------------------|-----------------------|-------|-------|------|
| STATIC PARAMETERS | | | | | | |
| Drain-source breakdown voltage | BV _{dss} | I _d =250 μA, V _{gs} =0V | 30 | | | V |
| Zero gate voltage drain current | I _{dss} | V _d =24V V _{gs} =0V T _j =55°C | | | 1 | μA |
| | | | | | 5 | |
| Gate-body leakage current | I _{gss} | V _d =0V, V _{gs} =±20V | | | 100 | nA |
| Gate threshold voltage | V _{gs(th)} | V _d =V _{gs} , I _d =250 μA | 1.0 | 1.9 | 3.0 | V |
| On state drain current | I _{d(on)} | V _{gs} =4.5V, V _d =5V | 20 | | | A |
| Static drain-source on-resistance | R _{ds(on)} | V _{gs} =10V I _d =6.9A T _j =125°C | | 22.5 | 28.0 | mΩ |
| | | | | 31.3 | 38.0 | |
| | | V _{gs} =4.5V, I _d =5A | | 34.5 | 42.0 | mΩ |
| Forward transconductance | G _{fs} | V _d =5V, I _d =6.9A | 10.0 | 15.4 | | S |
| Diode forward voltage | V _{sd} | I _s =1A | | 0.76 | 1.00 | V |
| Max. body-diode continuous current | I _s | | | | 3 | A |
| DYNAMIC PARAMETERS | | | | | | |
| Input capacitance | C _{iss} | | | 680 | | pF |
| Output capacitance | C _{oss} | V _{gs} =0V, V _d =15V, f=1MHz | | 102 | | pF |
| Reverse transfer capacitance | C _{rss} | | | 77 | | pF |
| Gate resistance | R _g | V _{gs} =0V, V _d =0V, f=1MHz | | 3 | | Ω |
| SWITCHING PARAMETERS | | | | | | |
| Total gate charge (10V) | Q _g | V _{gs} =10V, V _d =15V, I _d =6.9A | | 13.84 | | nC |
| Total gate charge (4.5V) | Q _g | | | 6.74 | | nC |
| Gate-source charge | Q _{gs} | | | 1.82 | | nC |
| Gate-drain charge | Q _{gd} | | | 3.20 | | nC |
| Turn-on delay time | t _{d(on)} | | | 4.6 | | ns |
| Turn-on rise time | t _r | V _{gs} =10V, V _d =15V | | 4.1 | | ns |
| Turn-off delay time | t _{d(off)} | R _l =2.2 Ω, R _{gen} =3 Ω | | 20.6 | | ns |
| Turn-off fall time | t _f | | | 5.2 | | ns |
| Body diode reverse recovery time | t _{rr} | I _f =6.9A, dI/dt=100A/μs | | 16.5 | | ns |
| Body diode reverse recovery charge | Q _{rr} | I _f =6.9A, dI/dt=100A/μs | | 7.8 | | nC |
| SCHOTTKY PARAMETERS | | | | | | |
| Forward voltage drop | V _f | I _f =3A | | 0.45 | 0.50 | V |
| Max. reverse leakage current | I _{rm} | V _r =24V | | 0.07 | 0.15 | mA |
| | | | T _j =125°C | 4.20 | 20.00 | |
| | | T _j =150°C | 15.00 | 60.00 | | |
| Junction capacitance | C _t | V _r =15V | | 120 | | pF |

NOTE :

- The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
- The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
- These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.

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Typical electrical and thermal characteristics

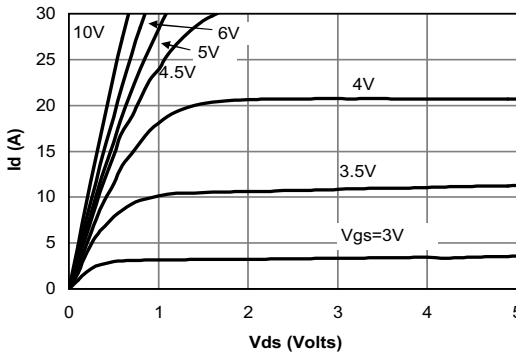


Figure 1: On-Region Characteristics

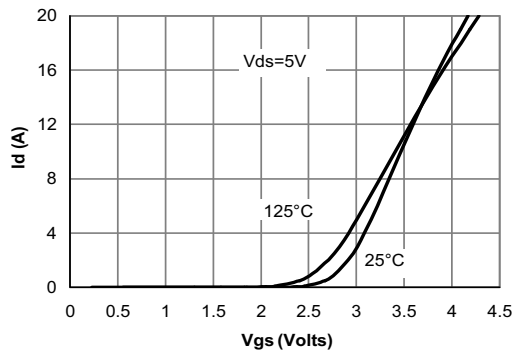


Figure 2: Transfer Characteristics

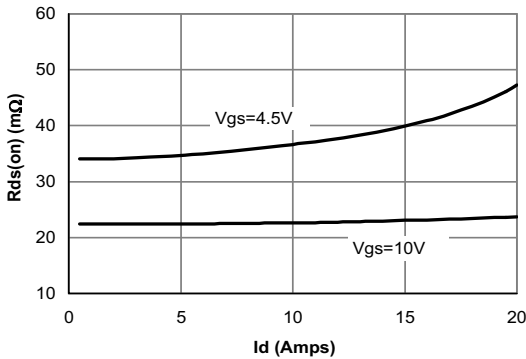


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

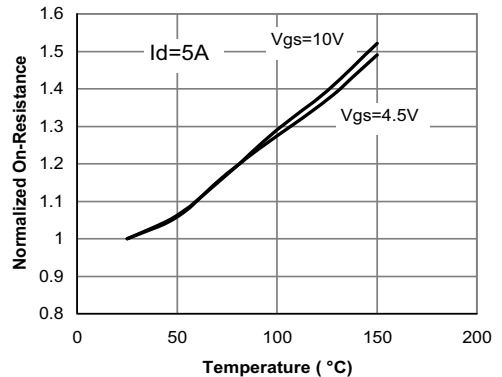


Figure 4: On-Resistance vs. Junction Temperature

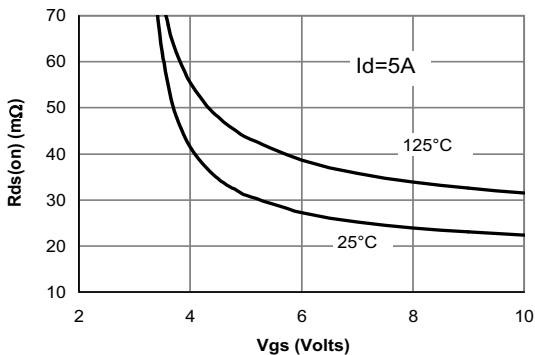


Figure 5: On-Resistance vs. Gate-Source Voltage

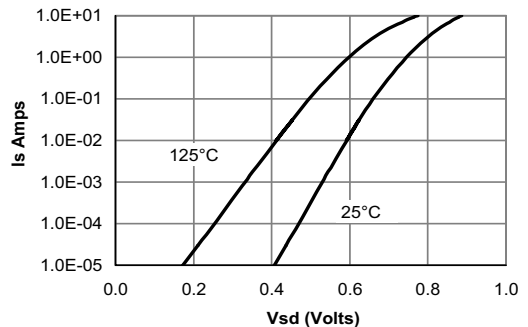


Figure 6: Body diode characteristics

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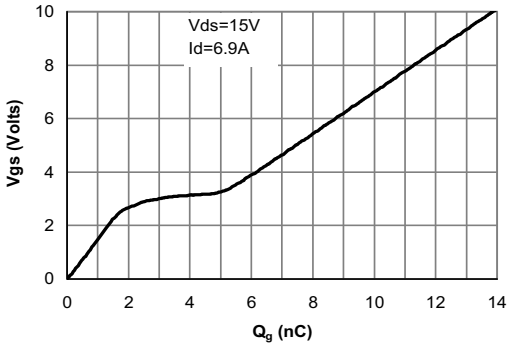


Figure 7: Gate-Charge characteristics

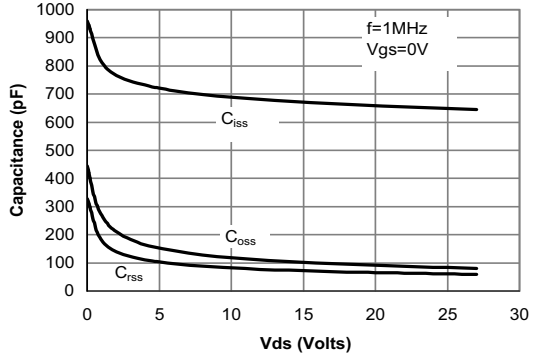


Figure 8: Capacitance Characteristics

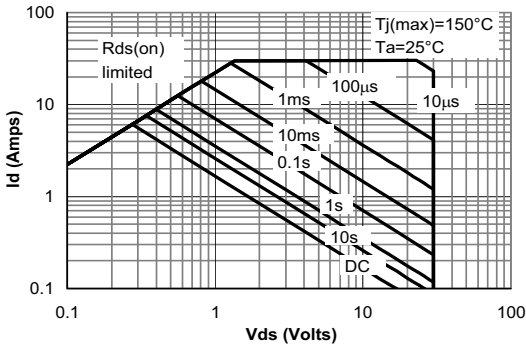


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

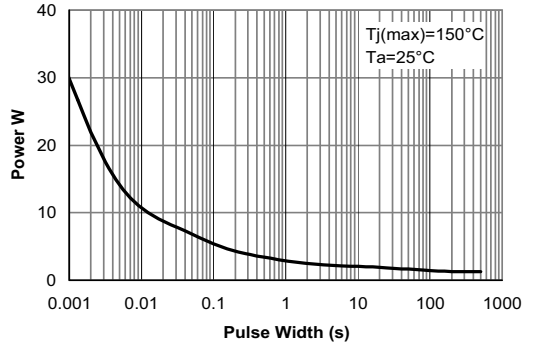


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

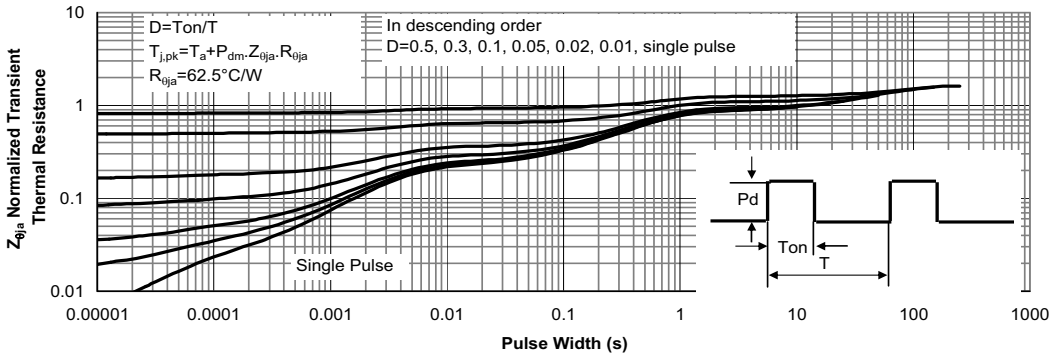


Figure 11: Normalized Maximum Transient Thermal Impedance

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Typical electrical and thermal characteristics (Schottky)

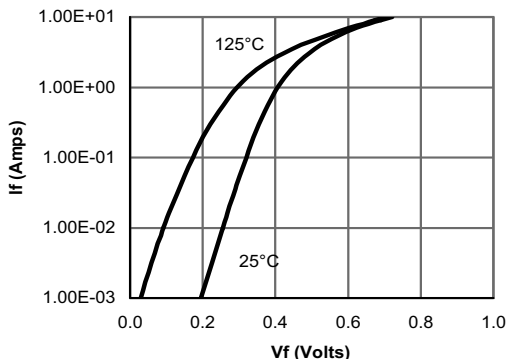


Figure 12: Schottky Forward Characteristics

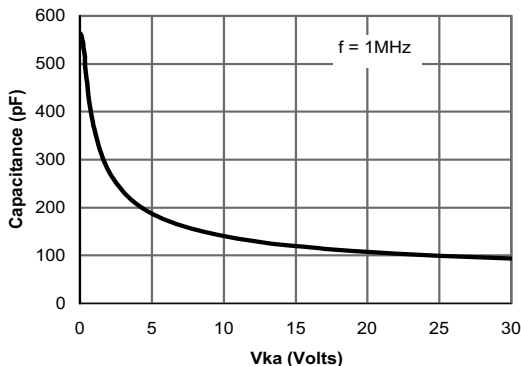


Figure 13: Schottky Capacitance Characteristics

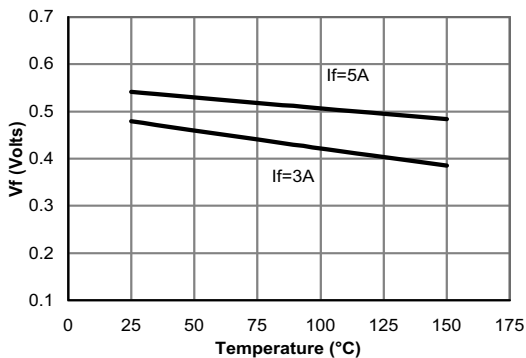


Figure 14: Schottky Forward Drop vs. Junction Temperature

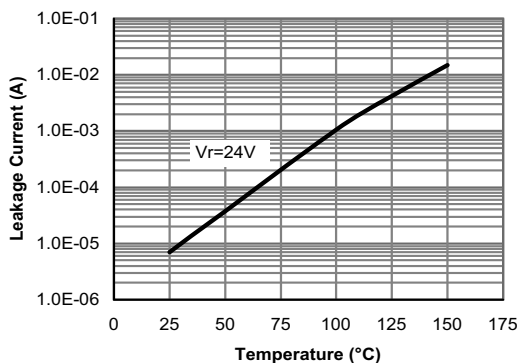


Figure 15: Schottky Leakage current vs. Junction Temperature

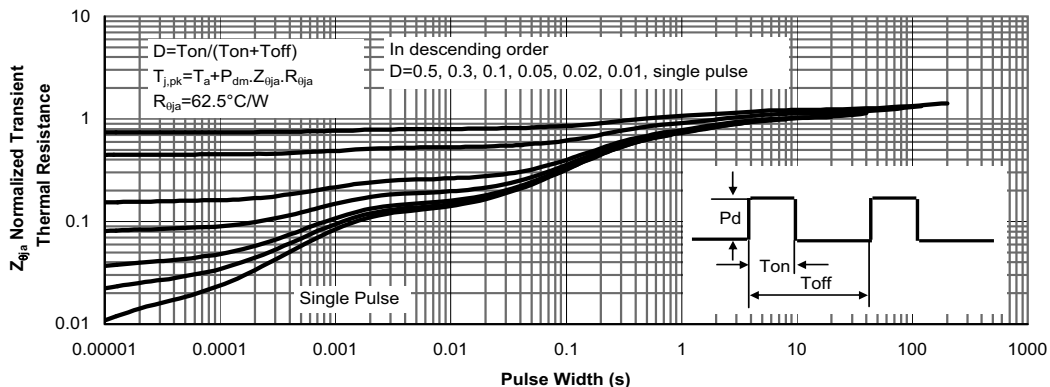


Figure 15: Schottky Normalized Maximum Transient Thermal Impedance